& October 2003

atober	7003			09/803,57
L Number	Hits	Search Text	DB	Time stamp
-	1571	204/\$.ccls. and (wafer or semiconductor) and seal	USPAT;	2003/10/27
			US-PGPUB;	08:45
			EPO; JPO;	
		·	DERWENT;	
			IBM_TDB	
-	2570	204/198,232,237,242,275.1,297.01,297.06,297.14.ccls	_	2003/10/27
			US-PGPUB;	08:45
			EPO; JPO;	
			DERWENT;	
			IBM_TDB	
_	1487	204/224r,224m.ccls.	USPAT;	2003/10/27
	1.07	20 1/ 22 11 /22 11110010.	US-PGPUB;	08:46
			EPO; JPO;	00.10
			DERWENT;	
			IBM TDB	
	E21	(204/108 222 227 242 275 1 207 01 207 04 207 141	_	2002/10/27
-	531	(204/198,232,237,242,275.1,297.01,297.06,297.14.ccl		2003/10/27
		204/224r,224m.ccls.) and (wafer or semiconductor)	US-PGPUB;	08:46
			EPO; JPO;	
			DERWENT;	
		·	IBW_TDB	
-	218	((204/198,232,237,242,275.1,297.01,297.06,297.14.cc		2003/10/27
		204/224r,224m.ccls.) and (wafer or semiconductor))	US-PGPUB;	10:30
		and seal	EPO; JPO;	·
			DERWENT;	
		·	IBM_TDB	
-	60	(204/198,232,237,242,275.1,297.01,297.06,297.14.ccl	s.USPAT;	2003/10/27
		204/224r,224m.ccls.) and sponge	US-PGPUB;	09:18
	ļ.		EPO; JPO;	
	,	•	DERWENT;	
			IBM_TDB	
_	2	6176992.pn.	USPAT;	2003/10/27
			US-PGPUB;	09:25
			EPO; JPO;	
,			DERWENT;	,
			IBM_TDB	
-	14	("3595089" "4610772" "5024735" "5171412"	USPAT	2003/10/27
		"5429733" "5558568" "5692947" "5755859"		09:26
		"5807165" "5833820" "5863412" "5930669"	· ·	-7
		"5933753" "6004880").PN.		
_	2	6228233.pn.	USPAT;	2003/10/27
-	• • •	0220233.pm	US-PGPUB;	09:33
			-	U7.33
			EPO; JPO;	
			DERWENT;	
		4007072	IBM_TDB	
-	2	4807973.pn.	USPAT;	2003/10/27
			US-PGPUB;	09:33
			EPO; JPO;	
			DERWENT;	'
			IBM_TDB	

-	23	(204/\$.ccls. or 205/\$.ccls.) and datta.in.	USPAT;	2003/10/27
			US-PGPUB;	10:33
·		·	EPO; JPO;	,
			DERWENT;	
ŀ			IBM_TDB	
-	3838	204/198,232,237,242,275.1,297.01,297.06,297.14.ccls	. USPAT;	2003/10/27
		204/224r,224m.ccls.	US-PGPUB;	10:53
			EPO; JPO;	
1		·	DERWENT;	
			IBM_TDB	
-	313	(204/198,232,237,242,275.1,297.01,297.06,297.14.ccl	s.USPAT;	2003/10/27
		204/224r,224m.ccls.) and (temperature with (anode	US-PGPUB;	10:54
		or cathode or electrode))	EPO; JPO;	·
			DERWENT;	
			IBM_TDB	
-	67	(204/198,232,237,242,275.1,297.01,297.06,297.14.ccl	s.USPAT;	2003/10/27
	·	204/224r,224m.ccls.) and (temperature near2 (anode	US-PGPUB;	11:03
		or cathode or electrode))	EPO; JPO;	
		. "	DERWENT;	
			IBM_TDB	
_	10	3859196.URPN.	USPAT	2003/10/27 11:01
_	30	(204/198,232,237,242,275.1,297.01,297.06,297.14.ccl	s.USPAT;	2003/10/27 11:13
		204/224r,224m.ccls.) and ((temperature near2	US-PGPUB;	
		control\$5) with (anode or cathode or electrode))	EPO; JPO;	
+			DERWENT;	
			IBM_TDB	
-	2	("5507923" "6017437").PN.	USPAT	2003/10/27
				11:06
_	25	(204/198,232,237,242,275.1,297.01,297.06,297.14.ccl	s.USPAT;	2003/10/27 11:19
		204/224r,224m.ccls.) and ((coolant or (cooling adj	US-PGPUB;	
		(fluid or liquid))) with (anode or cathode or	EPO; JPO;	
		electrode))	DERWENT;	
			IBM_TDB	
_	531	(204/198,232,237,242,275.1,297.01,297.06,297.14.ccl	s.USPAT;	2003/10/27
		204/224r,224m.ccls.) and (wafer or semiconductor)	US-PGPUB;	11:20
			EPO; JPO;	
			DERWENT;	
			IBM_TDB	
-	375	((204/198,232,237,242,275.1,297.01,297.06,297.14.cc	_	2003/10/27
		204/224r,224m.ccls.) and (wafer or semiconductor))	US-PGPUB;	11:22
		and (coolant or (cooling fluid) or heat or heating)	EPO; JPO;	
			DERWENT;	
			IBM_TDB	·
-	176	((204/198,232,237,242,275.1,297.01,297.06,297.14.cc	_	2003/10/27
		204/224r,224m.ccls.) and (wafer or semiconductor))	US-PGPUB;	11:22
		and ((coolant or (cooling fluid) or heat or heating)	EPO; JPO;	
	·	with (anode or cahode or electrode))	DERWENT;	
			IBM_TDB	
-	93	((204/198,232,237,242,275.1,297.01,297.06,297.14.cc		2003/10/27 11:21
		204/224r,224m.ccls.) and (wafer or semiconductor))	US-PGPUB;	
		and ((coolant or (cooling fluid) or heat or heating)	EPO; JPO;	
		near3 (anode or cahode or electrode))	DERWENT;	
			IBM_TDB	

<u></u>		(/204/100 222 227 242 275 1 207 01 207 07 207 14	ALICDAT.	2002/10/27 11:21
-	9	((204/198,232,237,242,275.1,297.01,297.06,297.14.cc		2003/10/27 11:21
		204/224r,224m.ccls.) and (wafer or semiconductor))	US-PGPUB;	
		and ((coolant or (cooling adj fluid) or heat or heating)	EPO; JPO;	
		near3 (anode or cahode or electrode))	DERWENT;	
1			IBW_TDB	
-	197	((204/198,232,237,242,275.1,297.01,297.06,297.14.cc		2003/10/27
		204/224r,224m.ccls.) and (wafer or semiconductor))	US-PGPUB;	11:22
		and (coolant or (cooling adj fluid) or heat or heating)	EPO; JPO;	
			DERWENT;	
			IBM_TDB	
-	32	((204/198,232,237,242,275.1,297.01,297.06,297.14.cc	SUSPAT;	2003/10/27
		204/224r,224m.ccls.) and (wafer or semiconductor))	US-PGPUB;	11:22
		and ((coolant or (cooling adj fluid) or heat or heating)	EPO; JPO;	,
		with (anode or cahode or electrode))	DERWENT;	
		with (dilade of edited of electrode))	IBM_TDB	
	2	("5507923" "6017437").PN.	USPAT	2003/10/27
-		(330/323 001/43/).FIV.	USFAT	11:27
		0/0577	USPAT;	
-	0	868577.apn.		2003/10/27
			US-PGPUB;	11:42
			EPO; JPO;	
			DERWENT;	
			IBW_LDB	
-	22	(US-6077412-\$ or US-6017437-\$ or US-5951833-\$	USPAT;	2003/10/27
1		or US-5567300-\$ or US-5776330-\$ or	US-PGPUB	11:50
		US-6176992-\$ or US-6228233-\$ or US-6251235-\$		
	·	or US-6258240-\$ or US-6261433-\$ or		
		US-6270647-\$ or US-6328872-\$ or US-6334937-\$		
		or US-6103096-\$ or US-5284554-\$ or		
ļ		US-3859196-\$ or US-6398926-\$ or US-5228966-\$		
		or US-5198083-\$ or US-3894925-\$ or		
		US-3637468-\$).did. or (US-20020056647-\$).did.		
-	8	((US-6077412-\$ or US-6017437-\$ or US-5951833-\$	USPAT:	2003/10/27 11:51
		or US-5567300-\$ or US-5776330-\$ or	US-PGPUB;	
		US-6176992-\$ or US-6228233-\$ or US-6251235-\$	EPO; JPO;	
		or US-6258240-\$ or US-6261433-\$ or	DERWENT;	
		US-6270647-\$ or US-6328872-\$ or US-6334937-\$	IBM_TDB	
	•	or US-6103096-\$ or US-5284554-\$ or		
		US-3859196-\$ or US-6398926-\$ or US-5228966-\$		
		or US-5198083-\$ or US-3894925-\$ or		
		US-3637468-\$).did. or (US-20020056647-\$).did.)		
		and ((electrolyte or solution or fluid) with		
	-	(temperature or cool\$4 or heat\$4))		
	7	, , , , , , , , , , , , , , , , , , , ,	LICDAT.	2002/10/27
_	/	((US-6077412-\$ or US-6017437-\$ or US-5951833-\$	USPAT;	2003/10/27
		or US-5567300-\$ or US-5776330-\$ or	US-PGPUB;	12:32
		US-6176992-\$ or US-6228233-\$ or US-6251235-\$	EPO; JPO;	
		or US-6258240-\$ or US-6261433-\$ or	DERWENT;	
		US-6270647-\$ or US-6328872-\$ or US-6334937-\$	IBW_TDB	
		or US-6103096-\$ or US-5284554-\$ or		
		US-3859196-\$ or US-6398926-\$ or US-5228966-\$		
		or US-5198083-\$ or US-3894925-\$ or		
		US-3637468-\$).did. or (US-20020056647-\$).did.)		
		and (dc or (direct adj current))		